



Product Summary

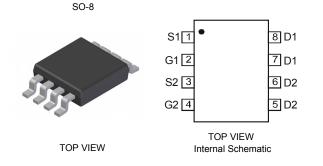
| V _{(BR)DSS} | R _{DS(on) max} | I _D T _A = +25°C |
|----------------------|---------------------------------|--|
| -30V | 65mΩ @ V _{GS} = -10V | -4.4A |
| | 115mΩ @ V _{GS} = -4.5V | -3.2A |

Description

This new generation MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- **Power Management Functions**
- Analog Switch
- Load Switch
- **Boost Switch**



Ordering Information (Note 4)

| Part Number | Case | Packaging |
|---------------|------|-------------------|
| DMP3098LSD-13 | SO-8 | 2,500/Tape & Reel |

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

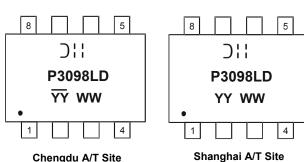
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:



Chengdu A/T Site

Features

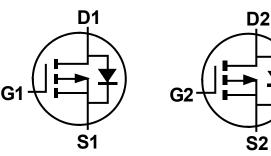
- **Dual P-Channel MOSFET**
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

DUAL P-CHANNEL ENHANCEMENT MODE MOSFET

- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.072g (approximate)



P-Channel MOSFET

∃ = Manufacturer's Marking

YYWW = Date Code Marking

WW = Week (01 - 53)

YY or \overline{YY} = Year (ex: 14 = 2014)

P3098LD = Product Type Marking Code

YY = Date Code Marking for SAT (Shanghai Assembly/ Test site) YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)

P-Channel MOSFET

DMP3098LSD Document number: DS31448 Rev. 4 - 2



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Cha | racteristic | | Symbol | Value | Units |
|-------------------------------|-----------------|--|------------------|--------------|-------|
| Drain-Source Voltage | | | V _{DSS} | -30 | V |
| Gate-Source Voltage | | | V _{GSS} | ±20 | V |
| Drain Current (Note 5) | Steady State | T _A = +25°C T _A = +70°C | ۱ _D | -4.4 -3.3 | А |
| Pulsed Drain Current (Note 6) | | | I _{DM} | -15 | A |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|----------------------------------|-------------|------|
| Total Power Dissipation (Note 5) | PD | 1.8 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | $R_{	ext{	heta}JA}$ | 70 | °C/W |
| Operating and Storage Temperature Range | T _{J,} T _{STG} | -55 to +150 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Мах | Unit | Test Condition | |
|-----------------------------------|---------------------|------|------------|-----------|--------------------|---|--|
| OFF CHARACTERISTICS (Note 7) | Cymbol . | | .,,,, | mux | 01110 | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -30 | | | V | V _{GS} = 0V, I _D = -250µA | |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | -1 | μA | V _{DS} = -30V, V _{GS} = 0V | |
| Gate-Source Leakage | I _{GSS} | | _ | ±100 | nA | V _{GS} = ±20V, V _{DS} = 0V | |
| ON CHARACTERISTICS (Note 7) | | | • | • | • | | |
| Gate Threshold Voltage | V _{GS(th)} | -1 | 1.7 | -2.1 | V | $V_{DS} = V_{GS}, I_D = -250 \mu A$ | |
| Static Drain-Source On-Resistance | Rds(on) | _ | 56 98 | 65 115 | mΩ | V _{GS} = -10V, I _D = -5.0A V _{GS} = -4.5V, I _D = -4.0A | |
| Forward Transconductance | g fs | _ | 5.2 | _ | S | V _{DS} = -10V, I _D = -5.0A | |
| Diode Forward Voltage (Note 7) | V _{SD} | -0.5 | _ | -1.2 | V | V _{GS} = 0V, I _S = -2.6A | |
| DYNAMIC CHARACTERISTICS | | | _ | _ | | | |
| Input Capacitance | C _{iss} | _ | 336 | _ | pF | | |
| Output Capacitance | C _{oss} | _ | 70 | _ | pF | $V_{DS} = -25V, V_{GS} = 0V$ f = 1.0MHz | |
| Reverse Transfer Capacitance | C _{rss} | _ | 49 | _ | pF | | |
| Gate Resistance | R _G | _ | 4.6 | _ | Ω | V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz | |
| SWITCHING CHARACTERISTICS | | | | | | | |
| Total Gate Charge | Qg | — | 4.0 7.8 | — | nC V _{DS} | V_{DS} = -15V, V_{GS} = -4.5V, I_D = -5.0A V_{DS} = -15V, V_{GS} = -10V, I_D = -5.0A | |
| Gate-Source Charge | Q _{gs} | | 1.0 | _ | | V_{DS} = -15V, V_{GS} = -4.5V, I_D = -5.0A | |
| Gate-Drain Charge | Q _{gd} | | 2.5 | _ | | V_{DS} = -15V, V_{GS} = -4.5V, I_D = -5.0A | |
| Turn-On Delay Time | t _{d(on)} | | 6.0 | _ | | | |
| Rise Time | tr | _ | 5.0 | _ | | V _{DS} = -15V, V _{GS} = -10V, | |
| Turn-Off Delay Time | t _{d(off)} | _ | 17.6 | _ | ns | I_{D} = -1A, R_{G} = 6.0 Ω | |
| Fall Time | t _f | | 9.5 | _ | | | |

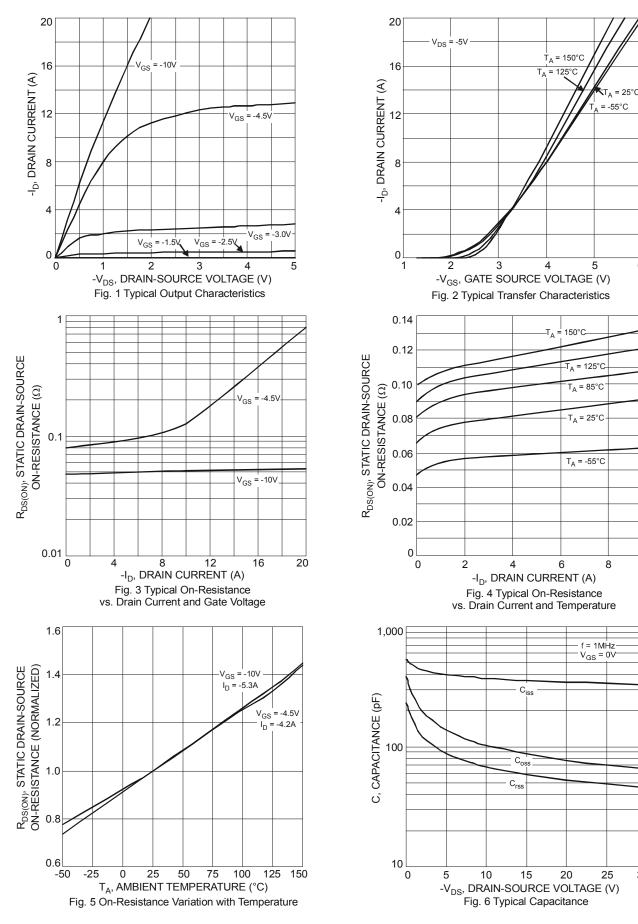
5. Device mounted on 2 oz. 1" x 1" Copper pads on 2" x 2" FR-4 PCB. Notes:

6. Pulse width ≤10µS, Duty Cycle ≤1%.
7. Short duration pulse test used to minimize self-heating effect.

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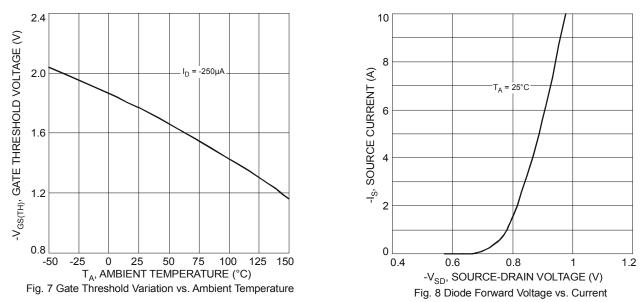
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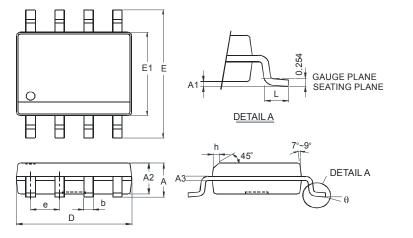
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Package Outline Dimensions

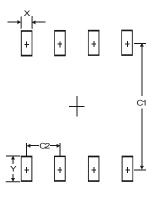
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| SO-8 | | | | | |
|----------------------|----------|------|--|--|--|
| Dim | Min | Max | | | |
| Α | - | 1.75 | | | |
| A1 | 0.10 | 0.20 | | | |
| A2 | 1.30 | 1.50 | | | |
| A3 | 0.15 | 0.25 | | | |
| b | 0.3 | 0.5 | | | |
| D | 4.85 | 4.95 | | | |
| E | 5.90 | 6.10 | | | |
| E1 | 3.85 | 3.95 | | | |
| е | 1.27 Typ | | | | |
| h | - | 0.35 | | | |
| L | 0.62 | 0.82 | | | |
| θ | 0° | 8° | | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Х | 0.60 |
| Y | 1.55 |
| C1 | 5.4 |
| C2 | 1.27 |



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